TECH PUBLIC
台舟电子

TPM4153-3

N-Channel Enhancement Mode MOSFET

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Features

- V_{DS} = 20V,I_D = 0.8A
  $R_{DS(ON)}$ < 250mΩ @ V_{GS}=4.5V
  $R_{DS(ON)}$ < 300mΩ@ V_{GS}=2.5V
- ESD Protection

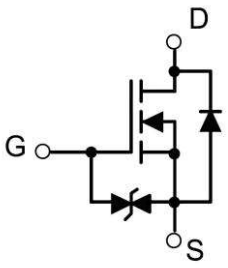
Application

- Load/Power Switching
- Interfacing Switching
- Battery Management for Ultra Small Portable Electronics
- Logic Level Shift

Package and Pin Configuration

SOT-523

Circuit diagram



Marking: A

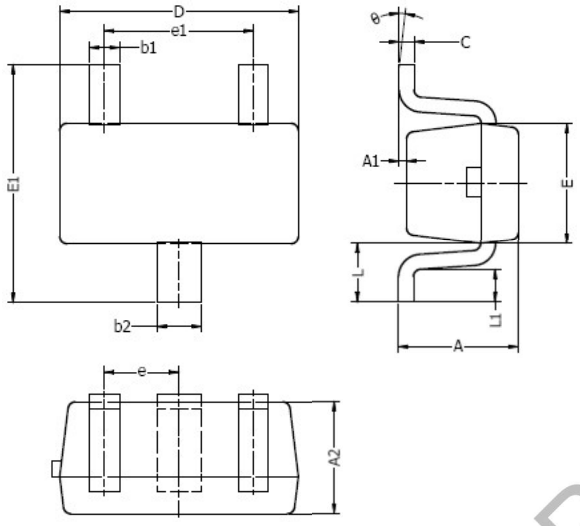
Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	±8	V
Continuous Drain Current	I_D	0.8	A
Pulsed Drain Current (t=300μs) (1)	I_{DM}	1.8	A
Power Dissipation (2)	P_D	280	mW
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	452	℃/W
Junction Temperature	T_J	150	℃
Storage Temperature	T_{STG}	-55~ +150	℃

Electrical Characteristics (T_A = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D =250μA	20			V
Zero gate voltage drain current	I_{DSS}	V_{DS} =20V,V_{GS} = 0V			1	μA
Gate-body leakage current	I_{GSS}	V_{GS} =±8 V, V_{DS} = 0V			±10	μA
Gate threshold voltage(3)	$V_{GS(th)}$	V_{DS} =V_{GS}, I_D =250μA	0.5	0.75	1.1	V
Drain-source on-resistance(3)	$R_{DS(on)}$	V_{GS} =4.5V, I_D =550mA		180	250	mΩ
		V_{GS} =2.5V I_D =450mA		230	300	
Forward tranconductance	g_{FS}	V_{DS} =5 V, I_D =500mA		1.7		S
Dynamic characteristics(4)						
Input Capacitance	C_{iss}	V_{DS} =16V,V_{GS} =0V,f =1MHz			120	pF
Output Capacitance	C_{oss}				20	
Reverse Transfer Capacitance	C_{rss}				15	
Switching Characteristics(4)						
Turn-on delay time	$t_{d(on)}$	V_{DD}=10V,I_D=500mA, V_{GS}=4.5V,R_G=10Ω		6.7		ns
Turn-on rise time	t_r			4.8		
Turn-off delay time	$t_{d(off)}$			17.3		
Turn-off fall time	t_f			7.4		
Source-Drain Diode characteristics						
Diode Forward voltage(3)	V_{DS}	I_S=0.15A, V_{GS} = 0V			1.2	V

SOT523 Package Outline Drawing



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.70	0.90	0.028	0.035
A1	0.00	0.10	0.000	0.004
A2	0.70	0.80	0.028	0.031
b1	0.15	0.25	0.006	0.010
b2	0.25	0.35	0.010	0.014
c	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
E1	1.45	1.75	0.057	0.069
e	0.50 TYP.		0.020 TYP.	
e1	0.90	1.10	0.035	0.043
L	0.40 REF.		0.016 REF.	
L1	0.10	0.30	0.004	0.012
θ	0°	8°	0°	8°

NOTES:
1. Above package outline conforms to JEITA EAIJ ED-7500A SC-75A.
2. Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.

Suggested Land Pattern